

REALTEK

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RTL8111GUS-CG

INTEGRATED 10/100/1000M ETHERNET CONTROLLER FOR PCI EXPRESS APPLICATIONS

DATASHEET

(CONFIDENTIAL: Development Partners Only)

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USING THIS DOCUMENT

This document is intended for the software engineer’s reference and provides detailed programming information.

Though every effort has been made to ensure that this document is current and accurate, more information may have become available subsequent to the production of this guide.

REVISION HISTORY

| Revision | Release Date | Summary |
|----------|--------------|---|
| 1.0 | 2012/10/16 | First release. |
| 1.1 | 2013/04/18 | Removed OBFF (Optimized Buffer Flush/Fill) & VMQ (Virtual Machine Queue). |
| 1.2 | 2013/05/14 | Modified section 8.3 Electrostatic Discharge Performance, page 20. |
| 1.3 | 2013/08/10 | Revised Table 24 DC Characteristics, page 22. |

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1. General Description

The Realtek RTL8111GUS-CG 10/100/1000M Ethernet controller combines a triple-speed IEEE 802.3 compliant Media Access Controller (MAC) with a triple-speed Ethernet transceiver, PCI Express bus controller, and embedded memory. With state-of-the-art DSP technology and mixed-mode signal technology, the RTL8111GUS offers high-speed transmission over CAT 5 UTP cable or CAT 3 UTP (10Mbps only) cable. Functions such as Crossover Detection and Auto-Correction, polarity correction, adaptive equalization, cross-talk cancellation, echo cancellation, timing recovery, and error correction are implemented to provide robust transmission and reception capability at high speeds.

The RTL8111GUS supports the PCI Express 1.1 bus interface for host communications with power management, and complies with the IEEE 802.3u specification for 10/100Mbps Ethernet and the IEEE 802.3ab specification for 1000Mbps Ethernet. It supports an auxiliary power auto-detect function, and will auto-configure related bits of the PCI power management registers in PCI configuration space. The RTL8111GUS features embedded One-Time-Programmable (OTP) memory. The RTL8111GUS provides a built-in switching regulator.

Advanced Configuration Power management Interface (ACPI)—power management for modern operating systems that are capable of Operating System-directed Power Management (OSPM)—is supported to achieve the most efficient power management possible. PCI MSI (Message Signaled Interrupt) and MSI-X are also supported.

In addition to the ACPI feature, remote wake-up (including AMD Magic Packet and Microsoft Wake-Up Frame) is supported in both ACPI and APM (Advanced Power Management) environments. To support WOL from a deep power down state (e.g., D3cold, i.e., main power is off and only auxiliary exists), the auxiliary power source must be able to provide the needed power for the RTL8111GUS. To further reduce power consumption, the RTL8111GUS also supports PCIe L1.Off and L1.Snooze.

The RTL8111GUS supports Protocol offload. It offloads some of the most common protocols to NIC hardware in order to prevent spurious wake-up and further reduce power consumption. The RTL8111GUS can offload ARP (IPv4) and NS (IPv6) protocols while in the D3 power saving state.

The RTL8111GUS supports the ECMA (European Computer Manufacturers Association) proxy for sleeping hosts standard. The standard specifies maintenance of network connectivity and presence via proxies in order to extend the sleep duration of higher-powered hosts. It handles some network tasks on behalf of the host, allowing the host to remain in sleep mode for longer periods. Required and optional behavior of an operating proxy includes generating reply packets, ignoring packets, and waking the host.

The RTL8111GUS supports IEEE 802.3az-2010, also known as Energy Efficient Ethernet (EEE). IEEE 802.3az-2010 operates with the IEEE 802.3 Media Access Control (MAC) Sublayer to support operation

in Low Power Idle mode. When the Ethernet network is in low link utilization, EEE allows systems on both sides of the link to save power.

The RTL8111GUS is fully compliant with Microsoft NDIS5, NDIS6 (IPv4, IPv6, TCP, UDP) Checksum and Segmentation Task-offload (Large send and Giant send) features, and supports IEEE 802 IP Layer 2 priority encoding and IEEE 802.1Q Virtual bridged Local Area Network (VLAN). The above features contribute to lowering CPU utilization, especially benefiting performance when in operation on a network server.

The RTL8111GUS supports Receive-Side Scaling (RSS) to hash incoming TCP connections and load-balance received data processing across multiple CPUs. RSS improves the number of transactions per second and number of connections per second, for increased network throughput.

The device features inter-connect PCI Express technology. PCI Express is a high-bandwidth, low-pin-count, serial, interconnect technology that offers significant improvements in performance over conventional PCI and also maintains software compatibility with existing PCI infrastructure.

The RTL8111GUS is suitable for multiple market segments and emerging applications, such as desktop, mobile, workstation, server, communications platforms, and embedded applications.

2. Features

Hardware

- Integrated 10/100/1000M transceiver
- Auto-Negotiation with Next Page capability
- Supports PCI Express 1.1
- Supports pair swap/polarity/skew correction
- Crossover Detection & Auto-Correction
- Supports 1-Lane 2.5Gbps PCI Express Bus
- Embedded OTP memory
- Supports hardware ECC (Error Correction Code) function
- Supports hardware CRC (Cyclic Redundancy Check) function
- Transmit/Receive on-chip buffer support
- Supports PCI MSI (Message Signaled Interrupt) and MSI-X
- Supports 25MHz or 48MHz Oscillator
- Built-in switching regulator
- Supports power down/link down power saving/PHY disable mode
- Customized LEDs
- Controllable LED Blinking Frequency and Duty Cycle
- 32-pin QFN ‘Green’ package
- Supports EMAC-393 ECMA ProxZzzy Standard for sleeping hosts

- Supports LTR (Latency Tolerance Reporting)
- Supports 16-set 128-byte Wake-Up Frame pattern exact matching
- Supports Microsoft WPD (Wake Packet Detection)
- Supports PCIe L1.Off and L1.Snooze

IEEE

- Fully compliant with IEEE 802.3, IEEE 802.3u, IEEE 802.3ab
- Supports IEEE 802.1P Layer 2 Priority Encoding
- Supports IEEE 802.1Q VLAN tagging
- Supports IEEE 802.3az-2010 (EEE)
- Supports Full Duplex flow control (IEEE 802.3x)

Software Offload

- Microsoft NDIS5, NDIS6 Checksum Offload (IPv4, IPv6, TCP, UDP) and Segmentation Task-offload (Large send v1 and Large send v2) support
- Supports jumbo frame to 9K bytes
- Supports quad core Receive-Side Scaling (RSS)
- Supports Protocol Offload (ARP & NS)

3. System Applications

- PCI Express 10/100/1000M Ethernet on Motherboard, Notebook, or Embedded systems

4. Pin Assignments

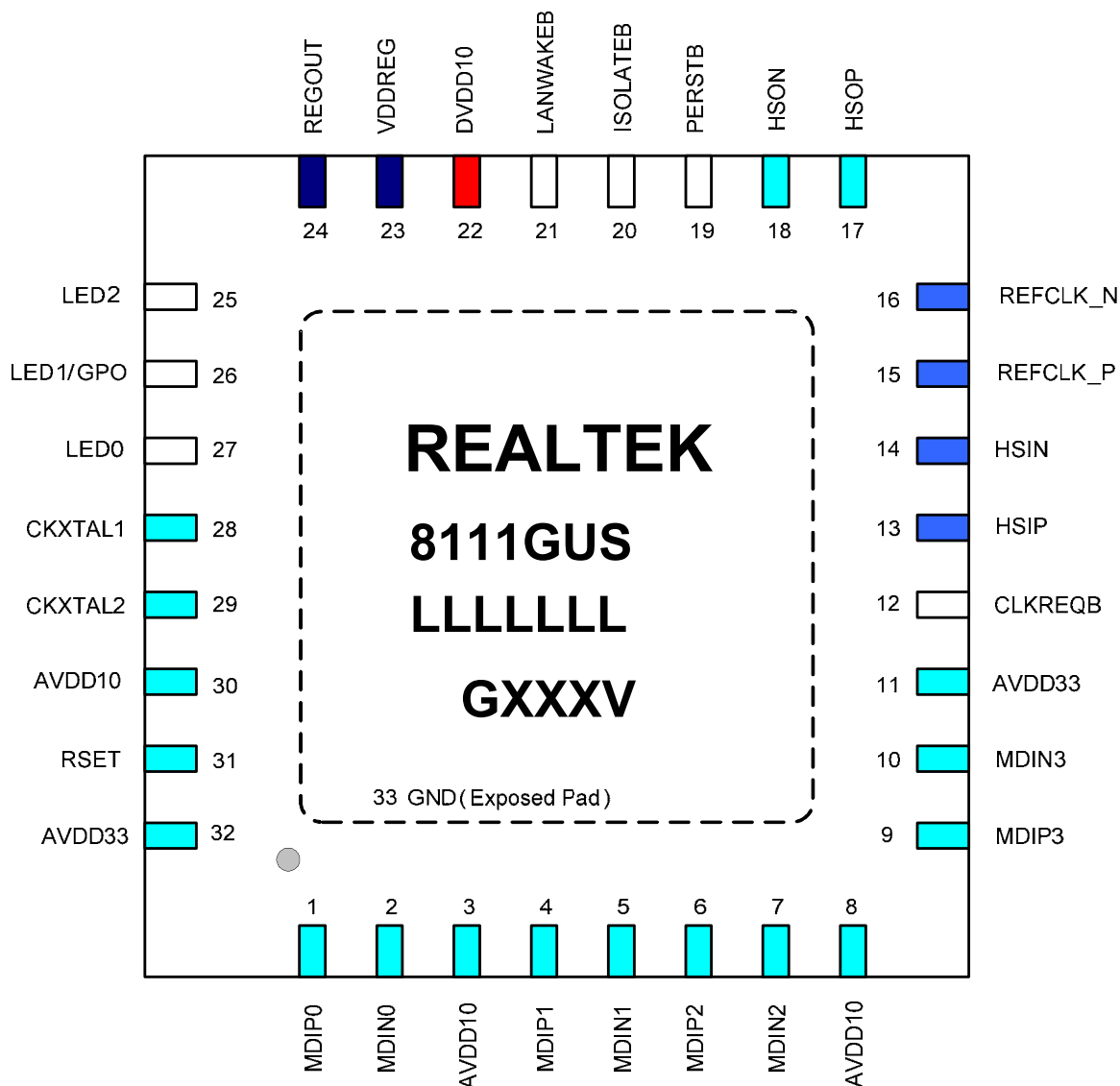


Figure 1. RTL8111GUS Pin Assignments

4.1. Package Identification

Green package is indicated by the 'G' in GXXXV (Figure 1).

5. Pin Descriptions

The signal type codes below are used in the following tables:

I: Input

O/D: Open Drain

O: Output

P: Power

5.1. Power Management/Isolation Pins

Table 1. Power Management/Isolation Pins

| Symbol | Type | Pin No | Description |
|----------|------|--------|--|
| LANWAKEB | O/D | 21 | Power Management Event (Open Drain; Active Low). Used to reactivate the PCI Express slot's main power rails and reference clocks. |
| ISOLATEB | I | 20 | Isolate Pin (Active Low). Used to isolate the RTL8111GUS from the PCI Express bus. The RTL8111GUS will not drive its PCI Express outputs (excluding LANWAKEB) and will not sample its PCI Express input as long as the Isolate pin is asserted. |

5.2. PCI Express Interface Pins

Table 2. PCI Express Interface Pins

| Symbol | Type | Pin No | Description |
|----------|------|--------|--|
| REFCLK_P | I | 15 | PCI Express Differential Reference Clock Source (100MHz \pm 300ppm). |
| REFCLK_N | I | 16 | |
| HSOP | O | 17 | PCI Express Transmit Differential Pair. |
| HSOP | O | 18 | |
| HSIP | I | 13 | PCI Express Receive Differential Pair. |
| HSIN | I | 14 | |
| PERSTB | I | 19 | PCI Express Reset Signal (Active Low). When the PERSTB is asserted at power-on state, the RTL8111GUS returns to a pre-defined reset state and is ready for initialization and configuration after the de-assertion of the PERSTB. |
| CLKREQB | O/D | 12 | Reference Clock Request Signal. This signal is used by the RTL8111GUS to request starting of the PCI Express reference clock. |

5.3. Transceiver Interface Pins

Table 3. Transceiver Interface Pins

| Symbol | Type | Pin No | Description |
|--------|------|--------|--|
| MDIP0 | IO | 1 | In MDI mode, this is the first pair in 1000Base-T, i.e., the BI_DA+/- pair, and is the transmit pair in 10Base-T and 100Base-TX. |
| MDIN0 | IO | 2 | |
| MDIP1 | IO | 4 | In MDI mode, this is the second pair in 1000Base-T, i.e., the BI_DB+/- pair, and is the receive pair in 10Base-T and 100Base-TX. |
| MDIN1 | IO | 5 | |
| MDIP2 | IO | 6 | In MDI mode, this is the third pair in 1000Base-T, i.e., the BI_DC+/- pair. In MDI crossover mode, this pair acts as the BI_DD+/- pair. |
| MDIN2 | IO | 7 | |
| MDIP3 | IO | 9 | In MDI mode, this is the fourth pair in 1000Base-T, i.e., the BI_DD+/- pair. In MDI crossover mode, this pair acts as the BI_DC+/- pair. |
| MDIN3 | IO | 10 | |

5.4. Clock Pins

Table 4. Clock Pins

| Symbol | Type | Pin No | Description |
|---------|------|--------|--|
| CKXTAL1 | I | 28 | Input of 25MHz or 48MHz Clock Reference. |
| CKXTAL2 | IO | 29 | Input of External Clock Source. Output of 25MHz or 48MHz Clock Reference. |

5.5. Regulator and Reference Pins

Table 5. Regulator and Reference Pins

| Symbol | Type | Pin No | Description |
|--------|------|--------|--|
| REGOUT | O | 24 | Switching Regulator 1.0V Output. |
| VDDREG | P | 23 | Digital 3.3V Power Supply for Switching Regulator. |
| RSET | I | 31 | Reference (External Resistor Reference). |

Note: See section 6.11, page 17 for additional information.

5.6. LED Pins

Table 6. LED Pins

| Symbol | Type | Pin No | Description |
|----------|------|--------|---|
| LED0 | O | 27 | See Section 6.2 Customizable LED Configuration, Page 9 for Details. |
| LED1/GPO | O | 26 | |
| LED2 | O | 25 | |

Note 1: During power down mode, the LED signals are logic high.

Note 2: The default value of the (LEDS1, LED0)=(1, 1).

Note 3: The LED1 pin can be changed to a GPO pin. The setting is changed from the register. Only one function (LED1 or GPIO) may be selected at one time (Default: LED1). For GPO function details, see section 5.8 GPO Pin, page 7.

5.7. Power and Ground Pins

Table 7. Power and Ground Pins

| Symbol | Type | Pin No | Description |
|--------|------|----------|---------------------------|
| AVDD10 | P | 3, 8, 30 | Analog 1.0V Power Supply. |
| DVDD10 | P | 22 | 1.0V Power Supply. |
| GND | P | 33 | Ground (Exposed Pad). |
| AVDD33 | P | 11, 32 | 3.3V Power Supply. |

Note: Refer to the latest schematic circuit for correct configuration.

5.8. GPO Pin

Table 8. GPO Pin

| Symbol | Type | Pin No | Description |
|----------|------|--------|---|
| GPO/LED1 | I/O | 26 | General Purpose Input/Output Pin. The setting is changed from the register. Only one function (LED1 or GPIO) may be selected at one time (default: LED1). Power Saving Feature: Output pin Link OK Feature: Output pin PHY Disable Mode (active low): Input pin |

Note: The LED1 pin can be changed to a GPO pin. The setting is changed from the register. Only one function (LED1 or GPIO) may be selected at one time (Default: LED1).

6. Functional Description

6.1. PCI Express Bus Interface

The RTL8111GUS complies with PCI Express Base Specification Revision 1.1, and runs at a 2.5GHz signaling rate with X1 link width, i.e., one transmit and one receive differential pair. The RTL8111GUS supports four types of PCI Express messages: interrupt messages, error messages, power management messages, and hot-plug messages. To ease PCB layout constraints, PCI Express lane polarity reversal is supported.

6.1.1. PCI Express Transmitter

The RTL8111GUS's PCI Express block receives digital data from the Ethernet interface and performs data scrambling with Linear Feedback Shift Register (LFSR) and 8B/10B coding technology into 10-bit code groups. Data scrambling is used to reduce the possibility of electrical resonance on the link, and 8B/10B coding technology is used to benefit embedded clocking, error detection, and DC balance by adding an overhead to the system through the addition of two extra bits. The data code groups are passed through its serializer for packet framing. The generated 2.5Gbps serial data is transmitted onto the PCB trace to its upstream device via a differential driver.

6.1.2. PCI Express Receiver

The RTL8111GUS's PCI Express block receives 2.5Gbps serial data from its upstream device to generate parallel data. The receiver's PLL circuits are re-synchronized to maintain bit and symbol lock. Through 8B/10B decoding technology and data de-scrambling, the original digital data is recovered and passed to the RTL8111GUS's internal Ethernet MAC to be transmitted onto the Ethernet media.

6.2. Customizable LED Configuration

The RTL8111GUS supports customizable LED operation modes via IO register offset 18h~19h. Table 9 describes the different LED actions.

Table 9. LED Select (IO Register Offset 18h~19h)

| Bit | Symbol | RW | Description |
|-------|---------|----|-------------------------|
| 15:12 | LEDCntl | RW | LED Feature Control. |
| 11:8 | LEDSEL2 | RW | LED Select for PINLED2. |
| 7:4 | LEDSEL1 | RW | LED Select for PINLED1. |
| 3:0 | LEDSEL0 | RW | LED Select for PINLED0. |

When implementing customized LEDs:

Configure IO register offset 18h~19h to support your own LED signals. For example, if the value in the IO offset 0x18 is 0x0CA9h (0000110010101001b), the LED actions are:

- LED 0: On only in 10M mode, with blinking during TX/RX
- LED 1: On only in 100M mode, with blinking during TX/RX
- LED 2: On only in 1000M mode, with blinking during TX/RX

Table 10. Customized LEDs

| Speed | LINK | | | ACT/Full |
|-----------------|----------|-----------|------------|----------|
| | Link 10M | Link 100M | Link 1000M | |
| LED 0 | Bit 0 | Bit 1 | Bit 2 | Bit 3 |
| LED 1 | Bit 4 | Bit 5 | Bit 6 | Bit 7 |
| LED 2 | Bit 8 | Bit 9 | Bit 10 | Bit 11 |
| Feature Control | Bit 12 | Bit 13 | Bit 14 | Bit 15 |

Note: There are two special modes:

LED OFF Mode: Set all bits to 0. All LED pin output become floating (power saving).

Fixed LED Mode: Set Option 1 LED table Mode: LED0=LED1=LED2=1 or 2 (see Table 11).

Table 11. Fixed LED Mode

| Bit31~Bit0 Value | LED0 | LED1 | LED2 |
|---------------------|----------|------|-------------------------|
| 1XXX 0001 0001 0001 | ACT | LINK | Full Duplex + Collision |
| 1XXX 0010 0010 0010 | Transmit | LINK | Receive |

Note: 'X' indicates 'irrelevant'.

Table 12. LED Feature Control-1

| Feature Control | Bit12 | Bit13 | Bit14 | Bit15 |
|-----------------|------------------|------------------|------------------|--|
| 0 | LED0 Low Active | LED1 Low Active | LED2 Low Active | Indicates Option 1 of Table 14 is Selected |
| 1 | LED0 High Active | LED1 High Active | LED2 High Active | Indicates Option 2 of Table 14 is Selected |

Table 13. LED Feature Control-2

| LED Pin | ACT=0 | ACT=1 |
|---------|---------------------|---|
| LINK=0 | Floating | All Speed ACT |
| LINK>0 | Selected Speed LINK | Option 1 (see Table 14): Selected Speed LINK+ Selected Speed ACT Option 2 (see Table 14): Selected Speed LINK+ All Speed ACT |

Table 14. LED Option 1 & Option 2 Settings

| Link Bit | | | Active Bit | Description | | |
|----------|-----|------|------------|---|--|--|
| 10 | 100 | 1000 | | Link | Option 1 LED Activity | Option 2 LED Activity |
| 0 | 0 | 0 | 0 | LED Off | | |
| 0 | 0 | 0 | 1 | - | Act ₁₀ +Act ₁₀₀ +Act ₁₀₀₀ | Act ₁₀ +Act ₁₀₀ +Act ₁₀₀₀ |
| 0 | 0 | 1 | 0 | Link ₁₀₀₀ | - | - |
| 0 | 0 | 1 | 1 | Link ₁₀₀₀ | Act ₁₀₀₀ | Act ₁₀ +Act ₁₀₀ +Act ₁₀₀₀ |
| 0 | 1 | 0 | 0 | Link ₁₀₀ | - | - |
| 0 | 1 | 0 | 1 | Link ₁₀₀ | Act ₁₀₀ | Act ₁₀ +Act ₁₀₀ +Act ₁₀₀₀ |
| 0 | 1 | 1 | 0 | Link ₁₀₀ +Link ₁₀₀₀ | - | - |
| 0 | 1 | 1 | 1 | Link ₁₀₀ +Link ₁₀₀₀ | Act ₁₀₀ +Act ₁₀₀₀ | Act ₁₀ +Act ₁₀₀ +Act ₁₀₀₀ |
| 1 | 0 | 0 | 0 | Link ₁₀ | - | - |
| 1 | 0 | 0 | 1 | Link ₁₀ | Act ₁₀ | Act ₁₀ +Act ₁₀₀ +Act ₁₀₀₀ |
| 1 | 0 | 1 | 0 | Link ₁₀ +Link ₁₀₀₀ | - | - |
| 1 | 0 | 1 | 1 | Link ₁₀ +Link ₁₀₀₀ | Act ₁₀ +Act ₁₀₀₀ | Act ₁₀ +Act ₁₀₀ +Act ₁₀₀₀ |
| 1 | 1 | 0 | 0 | Link ₁₀ +Link ₁₀₀ | - | - |
| 1 | 1 | 0 | 1 | Link ₁₀ +Link ₁₀₀ | Act ₁₀ +Act ₁₀₀ | Act ₁₀ +Act ₁₀₀ +Act ₁₀₀₀ |
| 1 | 1 | 1 | 0 | Link ₁₀ +Link ₁₀₀ +Link ₁₀₀₀ | - | - |
| 1 | 1 | 1 | 1 | Link ₁₀ +Link ₁₀₀ +Link ₁₀₀₀ | Act ₁₀ +Act ₁₀₀ +Act ₁₀₀₀ | Act ₁₀ +Act ₁₀₀ +Act ₁₀₀₀ |

Note:

Act₁₀ = LED blinking when Ethernet packets transmitted/received at 10Mbps.

Act₁₀₀ = LED blinking when Ethernet packets transmitted/received at 100Mbps.

Act₁₀₀₀ = LED blinking when Ethernet packets transmitted/received at 1000Mbps.

Link₁₀ = LED lit when Ethernet connection established at 10Mbps.

Link₁₀₀ = LED lit when Ethernet connection established at 100Mbps.

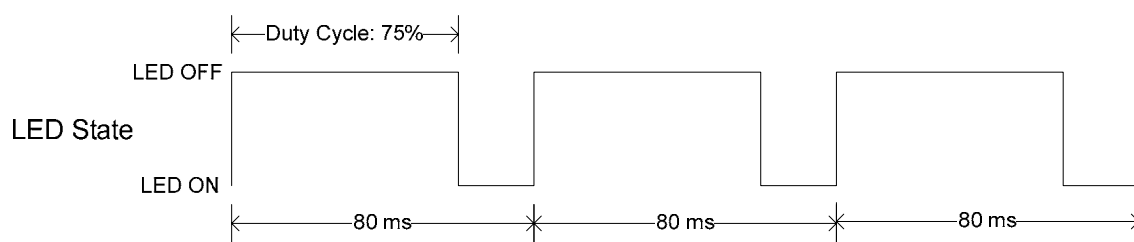
Link₁₀₀₀ = LED lit when Ethernet connection established at 1000Mbps.

6.2.1. LED Blinking Frequency Control

The RTL8111GUS supports LED blinking frequency control via IO register offset 1Ah to control user's LED blinking frequency and duty cycle (see Table 15). If the IO offset 0x1A is 0x0B (00001011b), the LED blinking frequency is 80ms and the duty cycle is 75%. The LED State is shown in Figure 2.

Table 15. LED Blinking Frequency Control (IO Offset 1Ah)

| Bit | RW | Description |
|-----|----|---|
| 3:2 | RW | LED Blinking Frequency. 0: 240ms 1: 160ms (default) 2: 80ms 3: Link Speed Dependent |
| 1:0 | RW | LED Blinking Duty Cycle. 0: 12.5% 1: 25% 2: 50% (default) 3: 75% |



Note: Assumes the LED is low active.

Figure 2. LED Blinking Frequency Example

6.3. PHY Transceiver

6.3.1. PHY Transmitter

Based on state-of-the-art DSP technology and mixed-mode signal processing technology, the RTL8111GUS operates at 10/100/1000Mbps over standard CAT.5 UTP cable (100/1000Mbps), or CAT.3 UTP cable (10Mbps).

GMII (1000Mbps) Mode

The RTL8111GUS's PCS layer receives data bytes from the MAC through the GMII interface and performs the generation of continuous code-groups through 4D-PAM5 coding technology. These code groups are passed through a waveform-shaping filter to minimize EMI effects, and are transmitted onto the 4-pair CAT5 cable at 125MBaud/s through a D/A converter.

MII (100Mbps) Mode

The transmitted 4-bit nibbles (TXD[3:0]) from the MAC, clocked at 25MHz (TXC), are converted into 5B symbol code through 4B/5B coding technology, then through scrambling and serializing, are converted to 125MHz NRZ and NRZI signals. The NRZI signals are passed to the MLT3 encoder, then to the D/A converter and transmitted onto the media.

MII (10Mbps) Mode

The transmitted 4-bit nibbles (TXD[3:0]) from the MAC, clocked at 2.5MHz (TXC), are serialized into 10Mbps serial data. The 10Mbps serial data is converted into a Manchester-encoded data stream and is transmitted onto the media by the D/A converter.

6.3.2. PHY Receiver

GMII (1000Mbps) Mode

Input signals from the media pass through the sophisticated on-chip hybrid circuit to separate the transmitted signal from the input signal for effective reduction of near-end echo. The received signal is processed with state-of-the-art technology, e.g., adaptive equalization, BLW (Baseline Wander) correction, cross-talk cancellation, echo cancellation, timing recovery, error correction, and 4D-PAM5 decoding. The 8-bit-wide data is recovered and is sent to the GMII interface at a clock speed of 125MHz. The RX MAC retrieves the packet data from the receive MII/GMII interface and sends it to the RX Buffer Manager.

MII (100Mbps) Mode

The MLT3 signal is processed with an ADC, equalizer, BLW (Baseline Wander) correction, timing recovery, MLT3 and NRZI decoder, descrambler, 4B/5B decoder, and is then presented to the MII interface in 4-bit-wide nibbles at a clock speed of 25MHz.

MII (10Mbps) Mode

The received differential signal is converted into a Manchester-encoded stream first. Next, the stream is processed with a Manchester decoder and is de-serialized into 4-bit-wide nibbles. The 4-bit nibbles are presented to the MII interface at a clock speed of 2.5MHz.

6.3.3. Link Down Power Saving Mode

The RTL8111GUS implements link-down power saving, greatly cutting power consumption when the network cable is disconnected. The RTL8111GUS automatically enters link down power saving mode ten seconds after the cable is disconnected from it. Once it enters link down power saving mode, it transmits normal link pulses on its TX pins and continues to monitor the RX pins to detect incoming signals. After it detects an incoming signal, it wakes up from link down power saving mode and operates in normal mode according to the result of the connection.

6.3.4. Next Page

If 1000Base-T mode is advertised, three additional Next Pages are automatically exchanged between the two link partners. Users can set PHY Reg4.15 to 1 to manually exchange extra Next Pages via Reg7 and Reg8 as defined in IEEE 802.3ab.

6.4. Power Management

The RTL8111GUS complies with ACPI (Rev 1.0, 1.0b, 2.0, 3.0), PCI Power Management (Rev 1.1), PCI Express Active State Power Management (ASPM), and Network Device Class Power Management Reference Specification (V1.0a), such as to support an Operating System-directed Power Management (OSPM) environment.

The RTL8111GUS can monitor the network for a Wake-Up Frame or a Magic Packet, and notify the system via a PCI Express Power Management Event (PME) Message, Beacon, or the LANWAKEB pin when such a packet or event occurs. The system can then be restored to a normal state to process incoming jobs.

When the RTL8111GUS is in power down mode (D1~D3):

- The RX state machine is stopped. The RTL8111GUS monitors the network for Wake-Up events such as a Magic Packet and Wake-Up Frame in order to wake up the system. When in power down mode, the RTL8111GUS will not reflect the status of any incoming packets in the ISR register and will not receive any packets into the RX on-chip buffer.
- The on-chip buffer status and packets that have already been received into the RX on-chip buffer before entering power down mode are held by the RTL8111GUS.
- Transmission is stopped. PCI Express transactions are stopped. The TX on-chip buffer is held.
- After being restored to D0 state, the RTL8111GUS transmits data that was not moved into the TX on-chip buffer during power down mode. Packets that were not transmitted completely last time are re-transmitted.

The D3_{cold}_support_PME bit (bit15, PMC register) and the Aux_I_b2:0 bits (bit8:6, PMC register) in PCI configuration space depend on the existence of Aux power. If aux. power is absent, the above 4 bits are all 0 in binary.

Magic Packet Wake-Up occurs only when the following conditions are met:

- The destination address of the received Magic Packet is acceptable to the RTL8111GUS, e.g., a broadcast, multicast, or unicast packet addressed to the current RTL8111GUS.
- The received Magic Packet does not contain a CRC error.
- The RTL8111GUS driver has set up the needed registers (automatically set), and the corresponding wake-up method (message, beacon, or LANWAKEB) can be asserted in the current power state.
- The Magic Packet pattern matches, i.e., $6 * FFh + MISC$ (can be none) + $16 * DID$ (Destination ID) in any part of a valid Ethernet packet.

A Wake-Up Frame event occurs only when the following conditions are met:

- The destination address of the received Wake-Up Frame is acceptable to the RTL8111GUS, e.g., a broadcast, multicast, or unicast address to the current RTL8111GUS.
- The received Wake-Up Frame does not contain a CRC error.
- The RTL8111GUS driver has set up the needed registers (automatically set).
- The 16-bit CRC of the received Wake-Up Frame matches the 16-bit CRC of the sample Wake-Up Frame pattern given by the local machine's OS. Or, the RTL8111GUS is configured to allow direct packet wake-up, e.g., a broadcast, multicast, or unicast network packet.
- The 128 bytes of the received Wake-Up Frame exactly matches the 128 bytes of the sample Wake-Up Frame pattern given by the local machine's OS.

Note 1: 16-bit CRC: The RTL8111GUS supports 16-set 16-bit CRC Wake-Up Frames (covering 128 mask bytes from offset 0 to 127 of any incoming network packet).

CRC16 polynomial = $x^{16} + x^{12} + x^5 + 1$.

Note 2: 128-byte Wake-Up Frame: The RTL8111GUS supports 16-set 128-byte Wake-Up Frames. If enabled, the 16-bit CRC Wake-Up match will be disabled.

The corresponding wake-up method (message or LANWAKEB) is asserted only when the following conditions are met:

- The PME_En bit (bit8, PMCSR) in PCI Configuration Space is set to 1.
- The RTL8111GUS may assert the corresponding wake-up method (message or LANWAKEB) in the current power state or in isolation state, depending on the PME_Support (bit15~11) setting of the PMC register in PCI Configuration Space.
- A Magic Packet, LinkUp, or Wake-Up Frame has been received.
- Writing a 1 to the PME_Status (bit15) of the PMCSR register in the PCI Configuration Space clears this bit and causes the RTL8111GUS to stop asserting the corresponding wake-up method (message or LANWAKEB) (if enabled).

When the RTL8111GUS is in power down mode, e.g., D1~D3, the IO, and MEM accesses to the RTL8111GUS are disabled. After a PERSTB assertion, the device's power state is restored to D0 automatically if the original power state was D3_{cold}. There is almost no hardware delay at the device's power state transition. When in ACPI mode, the device does not support PME (Power Management Enable) from D0 (this is the Realtek default setting). The setting may be changed from the eFUSE, if required.

6.5. Receive-Side Scaling (RSS)

The RTL8111GUS complies with the Network Driver Interface Specification (NDIS) 6.0 Receive-Side Scaling (RSS) technology for the Microsoft Windows family of operating systems. RSS allows packet receive-processing from a network adapter to be balanced across the number of available computer processors, increasing performance on multi-CPU platforms.

6.5.1. Receive-Side Scaling (RSS) Initialization

During RSS initialization, the Windows operating system will inform the RTL8111GUS that it should store the following parameters: hash function, hash type, hash bits, indirection table, BaseCPUNumber, and the secret hash key.

Hash Function

The default hash function is the Toeplitz hash function.

Hash Type

The hash types indicate which field of the packet needs to be hashed to get the hash result. There are several combinations of these fields, mainly, TCP/IPv4, IPv4, TCP/IPv6, IPv6, and IPv6 extension headers.

- TCP/IPv4 requires hash calculations over the IPv4 source address, the IPv4 destination address, the source TCP port and the destination TCP port.
- IPv4 requires hash calculations over the IPv4 source address and the IPv4 destination address.
- TCP/IPv6 requires hash calculations over the IPv6 source address, the IPv6 destination address, the source TCP port and the destination TCP port.
- IPv6 requires hash calculations over the IPv6 source address and the IPv6 destination address
(Note: The RTL8111GUS does not support the IPv6 extension header hash type in RSS).

Hash Bits

Hash bits are used to index the hash result into the indirection table

Indirection Table

The Indirection Table stores values that are added to the BaseCPUNumber to enable RSS interrupts to be restricted from some CPUs. The OS will update the Indirection Table to rebalance the load.

BaseCPUNumber

The lowest number CPU to use for RSS. BaseCPUNumber is added to the result of the indirection table lookup.

Secret Hash Key

The key used in the Toeplitz function. For different hash types, the key size is different.

6.5.2. Protocol Offload

Protocol offload is a task offload supported by Microsoft Windows 7. It maintains a network presence for a sleeping higher power host. Protocol offload prevents spurious wake-up and further reduces power consumption. It maintains connectivity while hosts are asleep, including receiving requests from other nodes on the network, ignoring packets, generating packets while in the sleep state (e.g., the Ethernet Controller will generate ARP responses if the same MAC and IPv4 address are provided in the configuration data), and intelligently waking up host systems. The RTL8111GUS supports the ECMA (European Computer Manufacturers Association) specification including proxy configuration and management, IPv4 ARP, IPv6 NDP, and wake-up packets. The RTL8111GUS also supports optional ECMA items such as QoS tagged packets and duplicate address detection.

6.5.3. RSS Operation

After the parameters are set, the RTL8111GUS will start hash calculations on each incoming packet and forward each packet to its correct queue according to the hash result. If the incoming packet is not in the hash type, it will be forwarded to the primary queue. The hash result plus the BaseCPUNumber will be indexed into the indirection table to get the correct CPU number. The RTL8111GUS uses three methods to inform the system of incoming packets: inline interrupt, MSI, and MSIX. Periodically the OS will update the indirection table to rebalance the load across the CPUs.

6.6. Energy Efficient Ethernet (EEE)

The RTL8111GUS supports IEEE 802.3az-2010, also known as Energy Efficient Ethernet (EEE), at 10Mbps, 100Mbps, and 1000Mbps. It provides a protocol to coordinate transitions to/from a lower power consumption level (Low Power Idle mode) based on link utilization. When no packets are being transmitted, the system goes to Low Power Idle mode to save power. Once packets need to be transmitted, the system returns to normal mode, and does this without changing the link status and without dropping/corrupting frames.

To save power, when the system is in Low Power Idle mode most of the circuits are disabled, however, the transition time to/from Low Power Idle mode is kept small enough to be transparent to upper layer protocols and applications.

EEE also specifies a negotiation method to enable link partners to determine whether EEE is supported and to select the best set of parameters common to both devices.

Refer to <http://www.ieee802.org/3/az/index.html> for more details.

6.7. *PHY Disable Mode*

The RTL8111GUS can power down the PHY using board-level control signals.

6.8. *Latency Tolerance Reporting (LTR)*

The RTL8111GUS supports PCIe 3.0 LTR (Latency Tolerance Reporting).

The LTR mechanism enables Endpoints to report service latency requirements for Memory Reads/Writes. The CPU utilizes LTR to determine transfers from low power (C7) to high power (C0) mode. See the PCIe 3.0 specification for details.

6.9. *Wake Packet Detection (WPD)*

The RTL8111GUS supports Microsoft Wake Packet Detection (WPD) to provide Wake-Up Frame information to the OS, e.g., PatternID, OriginalPacketSize, SavedPacketSize, SavedPacketOffset, etc. WPD helps prevent unwanted/unauthorized wake-up of a sleeping computer. Refer to the Microsoft Wake Packet Detection (WPD) Interface Specification for details.

6.10. *L1.Off and L1.Snooze*

The RTL8111GUS supports PCIe L1.Off and L1.Snooze power management features. L1+CLKREQ# stops (or provides) the REFCLK to a device by toggling the CLKREQB pin to enter L1.Off and L1.Snooze states (saving more power than L1+CLKREQ# only). Table 16 shows the PCIe Port Circuit On/Off states.

Table 16. L1.Off and L1.Snooze PCIe Port Circuit On/Off

| State | PLL | Common Mode Keeper | RX/TX |
|------------|-----|--------------------|----------|
| L1 | ON | On | Off/Idle |
| L1+CLKREQ# | Off | On | Off/Idle |
| L1.Snooze | Off | On | Off |
| L1.Off | Off | Off | Off |

6.11. *Switching Regulator*

The RTL8111GUS incorporates a state-of-the-art switching regulator that requires a well-designed PCB layout in order to achieve good power efficiency and lower the output voltage ripple and input overshoot. Note that the switching regulator 1.0V output pin (REGOUT) must be connected only to DVDD10 and AVDD10 (do not provide this power source to other devices).

7. Power Sequence

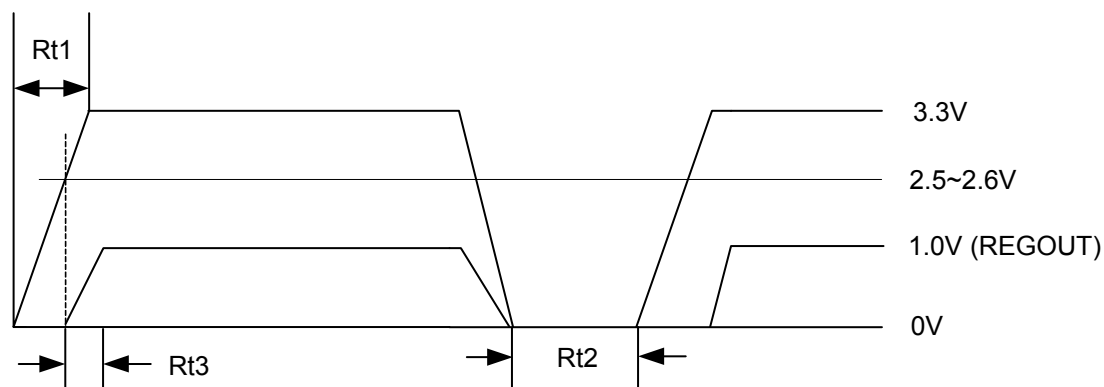


Figure 3. Power Sequence

Table 17. Power Sequence Parameters

| Symbol | Description | Min | Typical | Max | Units |
|--------|----------------------------|-----|---------|-----|-------|
| Rt1 | 3.3V Rise Time. | 0.5 | - | 100 | ms |
| Rt2 | 3.3V Off Time. | 50 | - | - | ms |
| Rt3 | 1.0V (REGOUT) Settle Time. | - | - | 15 | ms |

Note: See the following section for power sequence requirements.

7.1. Power Sequence Parameters

The RTL8111GUS does not support fast 3.3V rising under normal circumstance. The 3.3V rise time must be controlled over 0.5ms.

Rise Time > 0.5ms

No action to take.

Rise Time 0.1ms~0.5ms

If the rise time is between 0.1ms and 0.5ms, the customer MUST ensure that there is at least three times as much margin for inrush current to the RTL8111GUS so as to be safely under the system's 3.3V OCP threshold.

For example:

- Assume customer supply power rise time of the RTL8111GUS is 0.374ms
- The system 3.3V OCP is 9A
- The inrush current of other 3.3V devices is 5.64A

The inrush current to the RTL8111GUS must be less than 1.12A, otherwise an unanticipated system OCP may be triggered. It can be expressed in the following formula:

Inrush current to the RTL8111GUS < (System 3.3V OCP - inrush current of other 3.3V devices) / 3

Rise Time < 0.1ms

If the rise time is less than 0.1ms, there is risk of an unanticipated ESD trigger event, which may cause permanent damage to the RTL8111GUS.

If there is any action that involves consecutive ON/OFF toggling of the switching regulator source (3.3V), the design must make sure the OFF state of both the switching regulator source (3.3V) and output (1.0V) reach 0V, and the time period between the consecutive ON/OFF toggling action must be longer than 50ms.

8. Characteristics

8.1. Absolute Maximum Ratings

WARNING: Absolute maximum ratings are limits beyond which permanent damage may be caused to the device, or device reliability will be affected. All voltages are specified reference to GND unless otherwise specified.

Table 18. Absolute Maximum Ratings

| Symbol | Description | Minimum | Maximum | Unit |
|-------------------------------|---------------------------------|---------|---------|------|
| AVDD33 | Supply Voltage 3.3V | -0.3 | 3.6 | V |
| AVDD10, DVDD10 | Supply Voltage 1.0V | -0.3 | 1.2 | V |
| 3.3V DCinput 3.3V DCoutput | Input Voltage Output Voltage | -0.3 | 3.6 | V |
| 1.0V DCinput 1.0V DCoutput | Input Voltage Output Voltage | -0.3 | 1.2 | V |
| N/A | Storage Temperature | -55 | +125 | °C |

Note: Refer to the most updated schematic circuit for correct configuration.

8.2. Recommended Operating Conditions

Table 19. Recommended Operating Conditions

| Description | Pins | Minimum | Typical | Maximum | Unit |
|--|----------------|---------|---------|---------|------|
| Supply Voltage VDD | AVDD33 | 3.14 | 3.3 | 3.46 | V |
| | AVDD10, DVDD10 | 0.95 | 1.0 | 1.05 | V |
| Ambient Operating Temperature T _A | - | 0 | - | 70 | °C |
| Maximum Junction Temperature | - | - | - | 125 | °C |

Note: Refer to the most updated schematic circuit for correct configuration.

8.3. Electrostatic Discharge Performance

Table 20. Electrostatic Discharge Performance

| Test Item | Results |
|------------|---------------------|
| HBM ESD | All Pins: 4.5KV |
| MM ESD | All Pins: 200V |
| CDM ESD | All Pins: 1KV |
| Cable ESD* | All MDI Pins: 7KV |
| | All Pairs: 16KV |
| Latch Up | I/O Pins: 400mA |
| | Power Pins: 1.5xVDD |

Note: 'All MDI pins' means the ESD current is introduced to each MDI pin separately. 'All pairs' means the ESD current is introduced to the aggregated MDI pairs.

8.4. Crystal Requirements

Table 21. Crystal Requirements

| Symbol | Description/Condition | Minimum | Typical | Maximum | Unit |
|-----------------------------|--|---------|---------|---------|------|
| F _{ref} | Parallel Resonant Crystal Frequency Tolerance, Fundamental Mode, AT-Cut Type | - | 25 | - | MHz |
| F _{ref} Stability | Parallel Resonant Crystal Frequency Tolerance, Fundamental Mode, AT-Cut Type. T _a =0°C~70°C | -30 | - | +30 | ppm |
| F _{ref} Tolerance | Parallel Resonant Crystal Frequency Tolerance, Fundamental Mode, AT-Cut Type. T _a =25°C | -50 | - | +50 | ppm |
| F _{ref} Duty Cycle | Reference Clock Input Duty Cycle | 40 | - | 60 | % |
| ESR | Equivalent Series Resistance | - | - | 30 | Ω |
| Jitter | Broadband Peak-to-Peak Jitter | - | - | 200 | ps |
| DL | Drive Level | - | - | 0.3 | mW |

Note 1: The CLK source can come from other places in the system, but it must accord with the parameters above.

Note 2: Broadband RMS=9ps; 25KHz to 25MHz RMS=3ps.

8.5. Oscillator Requirements

Table 22. Oscillator Requirements

| Parameter | Condition | Minimum | Typical | Maximum | Unit |
|-------------------------------|---------------------------|---------|---------|---------|------|
| Frequency | - | - | 25/48 | - | MHz |
| Frequency Stability | T _a = 0°C~70°C | -30 | - | +30 | ppm |
| Frequency Tolerance | T _a = 25°C | -50 | - | +50 | ppm |
| Duty Cycle | - | 40 | - | 60 | % |
| Broadband Peak-to-Peak Jitter | - | - | - | 200 | ps |
| V _{peak-to-peak} | - | 3.15 | 3.3 | 3.45 | V |
| Rise Time | - | - | - | 10 | ns |
| Fall Time | - | - | - | 10 | ns |
| Operation Temp Range | - | 0 | - | 70 | °C |

Note 1: The CLK source can come from other places in the system, but it must accord with the parameters above.

Note 2: Broadband RMS=9ps; 25KHz to 48MHz RMS=3ps.

8.6. Environmental Characteristics

Table 23. Environmental Characteristics

| Parameter | Range | Units |
|----------------------------------|------------|-------|
| Storage Temperature | -55 ~ +125 | °C |
| Ambient Operating Temperature | 0 ~ 70 | °C |
| Moisture Sensitivity Level (MSL) | Level 3 | N/A |

8.7. DC Characteristics

Table 24. DC Characteristics

| Symbol | Parameter | Conditions | Minimum | Typical | Maximum | Units |
|-----------------|--|-------------------------------------|-----------|---------|-----------|-------|
| AVDD33 | 3.3V Supply Mean Voltage | - | 3.14 | 3.3 | 3.46 | V |
| AVDD10, DVDD10 | 1.0V Supply Mean Voltage | - | 0.95 | 1.0 | 1.05 | V |
| V _{oh} | Minimum High Level Output Voltage | I _{oh} = -4mA | 0.9*VDD33 | - | VDD33 | V |
| V _{ol} | Maximum Low Level Output Voltage | I _{ol} = 4mA | 0 | - | 0.1*VDD33 | V |
| V _{ih} | Minimum High Level Input Voltage | - | 2.0 | - | - | V |
| V _{il} | Maximum Low Level Input Voltage | - | - | - | 0.8 | V |
| I _{in} | Input Current | Vin = VDD33 or GND | 0 | - | 0.5 | μA |
| Icc33 | Average Operating Supply Current from 3.3V (does NOT include 1.0V power consumption) | At 1Gbps with heavy network traffic | - | 70 | - | mA |
| Icc10 | Average Operating Supply Current from 1.0V | At 1Gbps with heavy network traffic | - | 300 | - | mA |
| Isys33 | Average Operating Supply Current for total system 3.3V (includes 1.0V power consumption) | At 1Gbps with heavy network traffic | - | Note3 | - | mA |

Note 1: Refer to the latest schematic circuit for correct configuration.

Note 2: All Supply Mean Voltage power noise <±5% of Mean Voltage.

Note 3: The total operating current Isys33=Icc33 + (Icc10 / efficiency /3.3), where efficiency=0.75 for SWR-mode or efficiency=0.33 for LDO-mode.

8.8. Reflow Profile Recommendations

Table 25. Reflow Profile Recommendations

| Profile Feature | Sn-Pb Eutectic Assembly | Pb-Free Assembly |
|--|-------------------------|------------------|
| Minimum Preheat Temperature (T_{smin}) | 100°C | 150°C |
| Maximum Preheat Temperature (T_{smax}) | 150°C | 200°C |
| Preheat Time (t_s) from T_{smin} to T_{smax} | 60~120 seconds | 60~120 seconds |
| Ramp-Up Rate (T_L to T_p) | 3°C/second max. | 3°C/second max. |
| Liquidus Temperature (T_L) | 183°C | 217°C |
| Time (t_L) Maintained above T_L | 60~150 seconds | 60~150 seconds |
| Peak Package Body Temperature (T_p) | 235°C | 260°C |
| Time (t_p) ² within 5°C of Peak T_p | 20 seconds | 20 seconds |
| Ramp-Down Rate (T_p to T_L) | 6°C/second max. | 6°C/second max. |
| Time 25°C to Peak Temperature (T_p) | 6 minutes max. | 8 minutes max. |

Note 1: All temperatures refer to the topside of the package, measured on the package body surface.

Note 2: Tolerance for T_p is defined as a supplier's minimum and a user's maximum.

Note 3: Reference document: IPC/JEDEC J-STD-020D.1.

8.9. PCI Express Bus Parameters

8.9.1. Differential Transmitter Parameters

Table 26. Differential Transmitter Parameters

| Symbol | Parameter | Min | Typical | Max | Units |
|-----------------------------------|--|--------|---------|------------|----------|
| UI | Unit Interval | 399.88 | 400 | 400.12 | ps |
| $V_{TX-DIFFp-p}$ | Differential Peak-to-Peak Output Voltage | 0.800 | - | 1.05 | V |
| $V_{TX-DE-RATIO}$ | De-Emphasized Differential Output Voltage (Ratio) | -3.0 | -3.5 | -4.0 | dB |
| T_{TX-EYE} | Minimum TX Eye Width | 0.75 | - | - | UI |
| $T_{TX-EYE-MEDIAN-to-MAX-JITTER}$ | Maximum Time between The Jitter Median and Maximum Deviation from The Median | - | - | 0.125 | UI |
| $T_{TX-RISE}, T_{TX-FALL}$ | D+/D- TX Output Rise/Fall Time | 0.125 | - | - | UI |
| $V_{TX-CM-ACp}$ | RMS AC Peak Common Mode Output Voltage | - | - | 20 | mV |
| $V_{TX-CM-DCACTIVE-IDLEDELTA}$ | Absolute Delta of DC Common Mode Voltage During L0 and Electrical Idle | 0 | - | 100 | mV |
| $V_{TX-CM-DCLINE-DELTA}$ | Absolute Delta of DC Common Mode Voltage between D+ and D- | 0 | - | 25 | mV |
| $V_{TX-IDLE-DIFFp}$ | Electrical Idle Differential Peak Output Voltage | 0 | - | 20 | mV |
| $V_{TX-RCV-DETECT}$ | The Amount of Voltage Change Allowed During Receiver Detection | - | - | 600 | mV |
| $V_{TX-DC-CM}$ | The TX DC Common Mode Voltage | 0 | - | 3.6 | V |
| $I_{TX-SHORT}$ | TX Short Circuit Current Limit | - | - | 90 | mA |
| $T_{TX-IDLE-MIN}$ | Minimum Time Spent in Electrical Idle | 50 | - | - | UI |
| $T_{TX-IDLE-SETTO-IDLE}$ | Maximum Time to Transition to A Valid Electrical Idle After Sending An Electrical Idle Ordered Set | - | - | 20 | UI |
| $T_{TX-IDLE-TOTO-DIFF-DATA}$ | Maximum Time to Transition to Valid TX Specifications After Leaving An Electrical Idle Condition | - | - | 20 | UI |
| $RL_{TX-DIFF}$ | Differential Return Loss | 10 | - | - | dB |
| RL_{TX-CM} | Common Mode Return Loss | 6 | - | - | dB |
| $Z_{TX-DIFF-DC}$ | DC Differential TX Impedance | 80 | 100 | 120 | Ω |
| $L_{TX-SKEW}$ | Lane-to-Lane Output Skew | - | - | $500+2*UI$ | ps |
| C_{TX} | AC Coupling Capacitor | 75 | - | 200 | nF |
| $T_{crosslink}$ | Crosslink Random Timeout | 0 | - | 1 | ms |

Note 1: Refer to PCI Express Base Specification, rev.1.1, for correct measurement environment setting of each parameter.

Note 2: The data rate can be modulated with an SSC (Spread Spectrum Clock) from +0 to -0.5% of the nominal data rate frequency, at a modulation rate in the range not exceeding 30kHz – 33kHz. The $\pm 300ppm$ requirement still holds, which requires the two communicating ports be modulated such that they never exceed a total of 600ppm difference.

8.9.2. Differential Receiver Parameters

Table 27. Differential Receiver Parameters

| Symbol | Parameter | Min. | Typical | Max. | Units |
|--|--|--------|---------|--------|-------|
| UI | Unit Interval | 399.88 | 400 | 400.12 | ps |
| V _{RX-DIFFP-P} | Differential Input Peak-to-Peak Voltage | 0.175 | - | 1.05 | V |
| T _{RX-EYE} | Minimum Receiver Eye Width | 0.4 | - | - | UI |
| T _{RX-EYE-MEDIAN-to-MAX-JITTER} | Maximum Time Between The Jitter Median and Maximum Deviation from The Median | - | - | 0.3 | UI |
| V _{RX-CM-ACp} | AC Peak Common Mode Input Voltage | - | - | 150 | mV |
| RL _{RX-DIFF} | Differential Return Loss | 10 | - | - | dB |
| RL _{RX-CM} | Common Mode Return Loss | 6 | - | - | dB |
| Z _{RX-DIFF-DC} | DC Differential Input Impedance | 80 | 100 | 120 | Ω |
| Z _{RX-DC} | DC Input Impedance | 40 | 50 | 60 | Ω |
| Z _{RX-HIGH-IMP-DC} | Powered Down DC Input Impedance | 200k | - | - | Ω |
| V _{RX-IDLE-DET-DIFFP-P} | Electrical Idle Detect Threshold | 65 | - | 175 | mV |
| T _{RX-IDLE-DET-DIFF-INT} | Unexpected Electrical Idle Enter Detect Threshold Integration Time | - | - | 10 | ms |
| L _{RX-SKEW} | Total Skew | - | - | 20 | ns |

Note: Refer to PCI Express Base Specification, rev.1.1, for correct measurement environment setting of each parameter.

8.9.3. REFCLK Parameters

Table 28. REFCLK Parameters

| Symbol | Parameter | 100MHz Input | | Units | Note |
|--------------------------|---|--------------|--------|-------|-----------|
| | | Min | Max | | |
| Rise Edge Rate | Rising Edge Rate | 0.6 | 4.0 | V/ns | 2, 3 |
| Fall Edge Rate | Falling Edge Rate | 0.6 | 4.0 | V/ns | 2, 3 |
| V _{IH} | Differential Input High Voltage | +150 | - | mV | 2 |
| V _{IL} | Differential Input Low Voltage | - | -150 | mV | 2 |
| V _{CROSS} | Absolute Crossing Point Voltage | +250 | +550 | mV | 1, 4, 5 |
| V _{CROSS DELTA} | Variation of V _{CROSS} Over All Rising Clock Edges | - | +140 | mV | 1, 4, 9 |
| V _{RB} | Ring-Back Voltage Margin | -100 | +100 | mV | 2, 12 |
| T _{STABLE} | Time before V _{RB} is Allowed | 500 | - | ps | 2, 12 |
| T _{PERIOD AVG} | Average Clock Period Accuracy | -300 | +2800 | ppm | 2, 10, 13 |
| T _{PERIOD ABS} | Absolute Period (Including Jitter and Spread Spectrum) | 9.847 | 10.203 | ns | 2, 6 |
| T _{CCJITTER} | Cycle to Cycle Jitter | - | 150 | ps | 2 |
| V _{MAX} | Absolute Maximum Input Voltage | - | +1.15 | V | 1, 7 |
| V _{MIN} | Absolute Minimum Input Voltage | -0.3 | - | V | 1, 8 |

| Symbol | Parameter | 100MHz Input | | Units | Note |
|--------------------|---|--------------|-----|-------|-------|
| | | Min | Max | | |
| Duty Cycle | Duty Cycle | 40 | 60 | % | 2 |
| Rise-Fall Matching | Rising Edge Rate (REFCLK+) to Falling Edge Rate (REFCLK-) Matching | - | 20 | % | 1, 14 |
| Z _{C-DC} | Clock Source DC Impedance | 40 | 60 | Ω | 1, 11 |

Note 1: Measurement taken from single-ended waveform.

Note 2: Measurement taken from differential waveform.

Note 3: Measured from -150mV to +150mV on the differential waveform (derived from REFCLK+ minus REFCLK-). The signal must be monotonic through the measurement region for rise and fall time. The 300mV measurement window is centered on the differential zero crossing. See Figure 7, page 28.

Note 4: Measured at crossing point where the instantaneous voltage value of the rising edge of REFCLK+ equals the falling edge of REFCLK-. See Figure 4, page 27.

Note 5: Refers to the total variation from the lowest crossing point to the highest, regardless of which edge is crossing. Refers to all crossing points for this measurement. See Figure 4, page 27.

Note 6: Defines as the absolute minimum or maximum instantaneous period. This includes cycle to cycle jitter, relative ppm tolerance, and spread spectrum modulation. See Figure 6, page 27.

Note 7: Defined as the maximum instantaneous voltage including overshoot. See Figure 4, page 27.

Note 8: Defined as the minimum instantaneous voltage including undershoot. See Figure 4, page 27.

Note 9: Defined as the total variation of all crossing voltages of Rising REFCLK+ and Falling REFCLK-. This is the maximum allowed variance in VCROSS for any particular system. See Figure 4, page 27.

Note 10: Refer to Section 4.3.2.1 of the PCI Express Base Specification, Revision 1.1 for information regarding ppm considerations.

Note 11: System board compliance measurements must use the test load card described in Figure 10, page 29. REFCLK+ and REFCLK- are to be measured at the load capacitors CL. Single ended probes must be used for measurements requiring single ended measurements. Either single ended probes with math or differential probe can be used for differential measurements. Test load CL=2pF.

Note 12: TSTABLE is the time the differential clock must maintain a minimum ±150mV differential voltage after rising/falling edges before it is allowed to droop back into the VRB ±100mV differential range. See Figure 9, page 28.

Note 13: PPM refers to parts per million and is a DC absolute period accuracy specification. 1ppm is 1/1,000,000th of 100.000000MHz exactly, or 100Hz. For 300ppm then we have an error budget of 100Hz/ppm*300ppm=30kHz. The period is to be measured with a frequency counter with measurement window set to 100ms or greater. The ±300ppm applies to systems that do not employ Spread Spectrum or that use common clock source. For systems employing Spread Spectrum there is an additional 2500ppm nominal shift in maximum period resulting from the 0.5% down spread resulting in a maximum average period specification of +2800ppm.

Note 14: Matching applies to rising edge rate for REFCLK+ and falling edge rate for REFCLK-. It is measured using a ±75mV window centered on the median cross point where REFCLK+ rising meets REFCLK- falling. The median cross point is used to calculate the voltage thresholds the oscilloscope is to use for the edge rate calculations. The Rise Edge Rate of REFCLK+ should be compared to the Fall Edge Rate of REFCLK-; the maximum allowed difference should not exceed 20% of the slowest edge rate. See Figure 5, page 27.

Note 15: Refer to PCI Express Card Electromechanical Specification, rev.1.1, for correct measurement environment setting of each parameter.

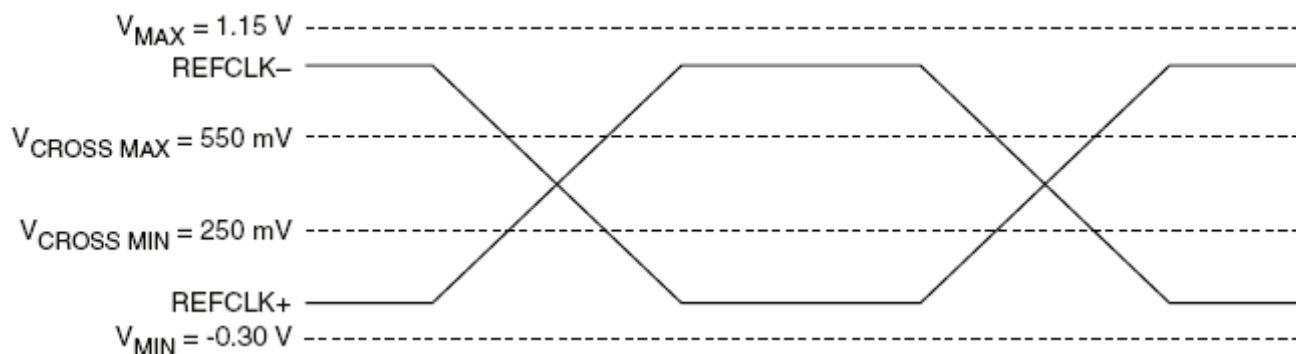


Figure 4. Single-Ended Measurement Points for Absolute Cross Point and Swing

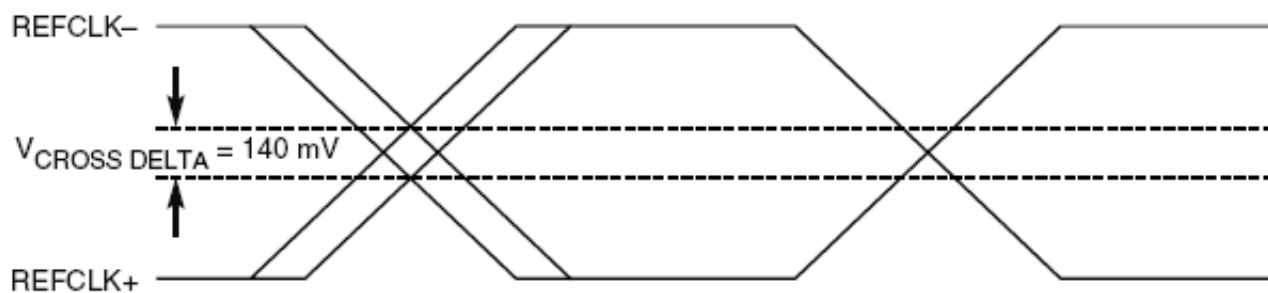


Figure 5. Single-Ended Measurement Points for Delta Cross Point

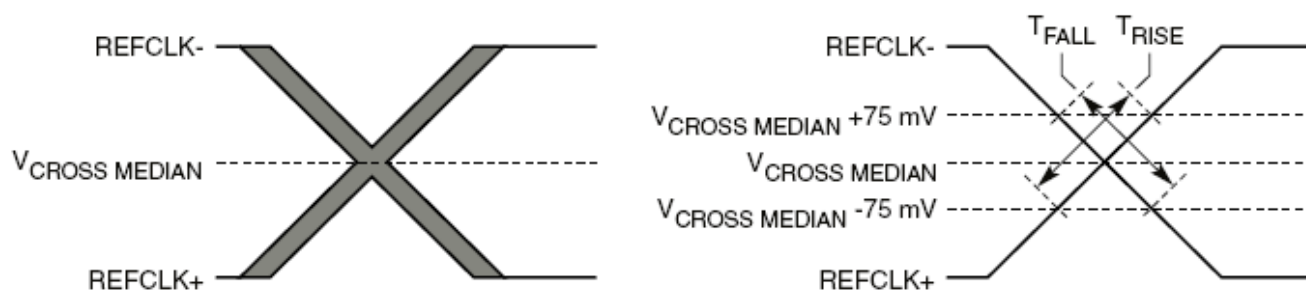


Figure 6. Single-Ended Measurement Points for Rise and Fall Time Matching

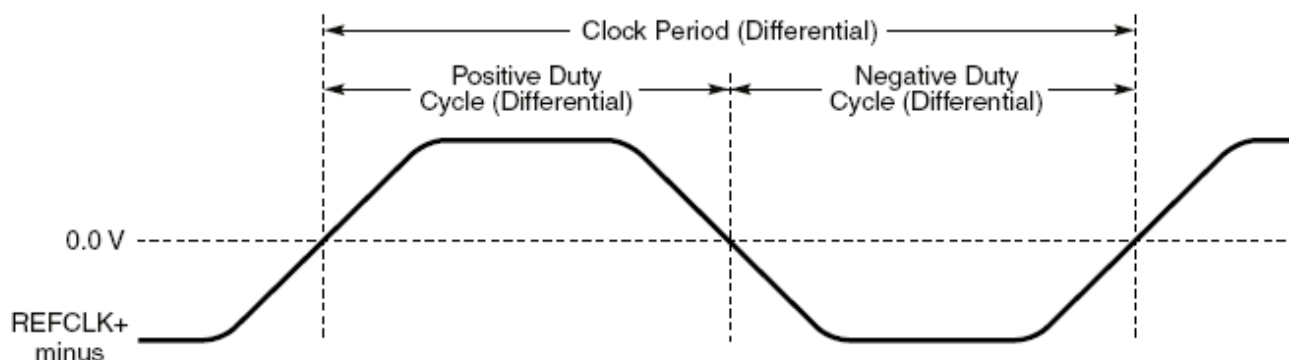


Figure 7. Differential Measurement Points for Duty Cycle and Period

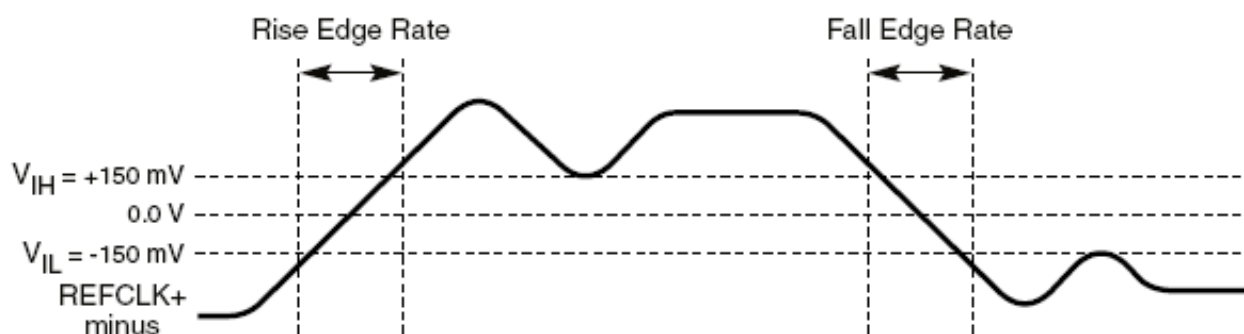


Figure 8. Differential Measurement Points for Rise and Fall Time

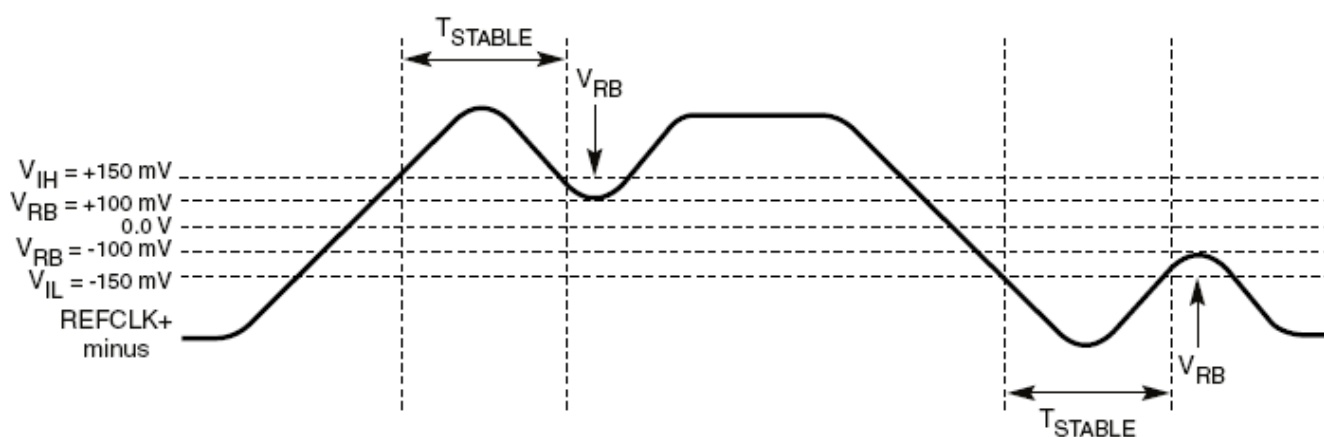


Figure 9. Differential Measurement Points for Ringback

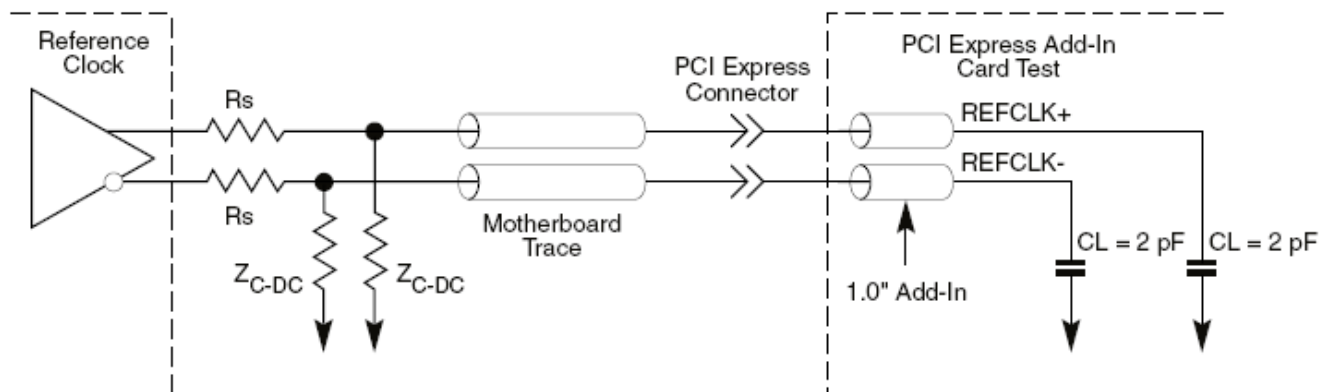


Figure 10. Reference Clock System Measurement Point and Loading

8.9.4. Auxiliary Signal Timing Parameters

Table 29. Auxiliary Signal Timing Parameters

| Symbol | Parameter | Min | Max | Units |
|------------------|---|-----|-----|---------|
| T_{PVPERL} | Power Stable to PERSTB Inactive | 100 | - | ms |
| $T_{PERST-CLK}$ | REFCLK Stable before PERSTB Inactive | 100 | - | μ s |
| T_{PERST} | PERSTB Active Time | 100 | - | μ s |
| $T_{PERSTB-RTD}$ | PERSTB Rising Time Duration | 10 | - | ms |
| T_{FAIL} | Power Level Invalid to PWRGD Inactive | - | 500 | ns |
| T_{PWRON} | 3.3Vaux Power On Time (Refer to Section 7, Page 18) | - | - | ms |

Note 1: T_{FAIL} means 500 ns (maximum) from the power rail going out of specification (exceeding the specified tolerances by more than 500 mV). Refer to PCI Local Bus Specification rev. 3.0 for further information. T_{FAIL} can be disregarded when implementation and timing of T_{FAIL} will not affect any LAN functions.

Note 2: The ISOLATEB pin should follow the behavior of the 3.3V main power waveform.

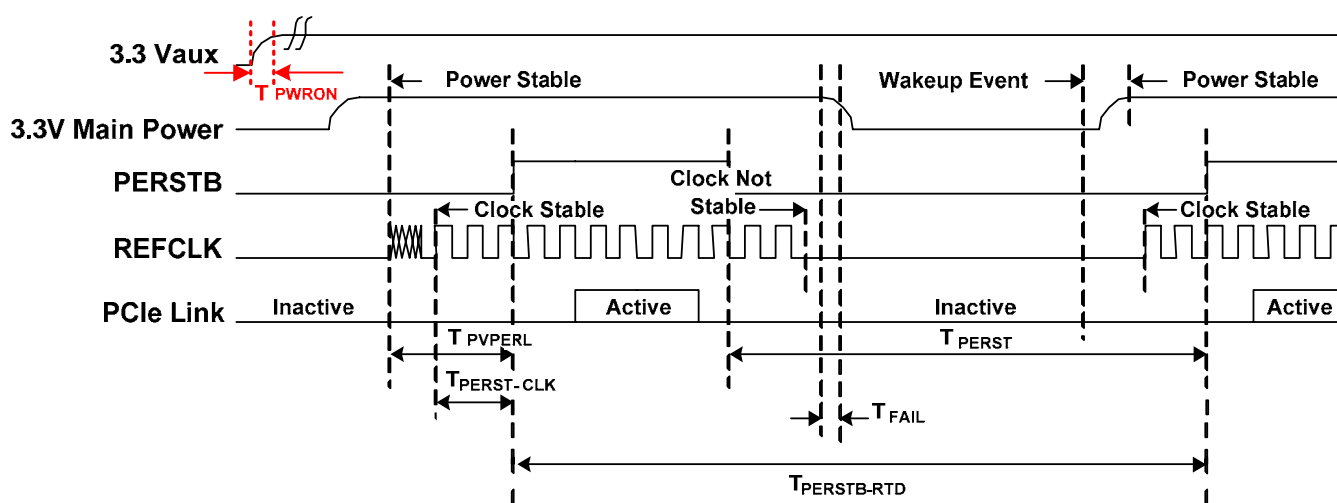
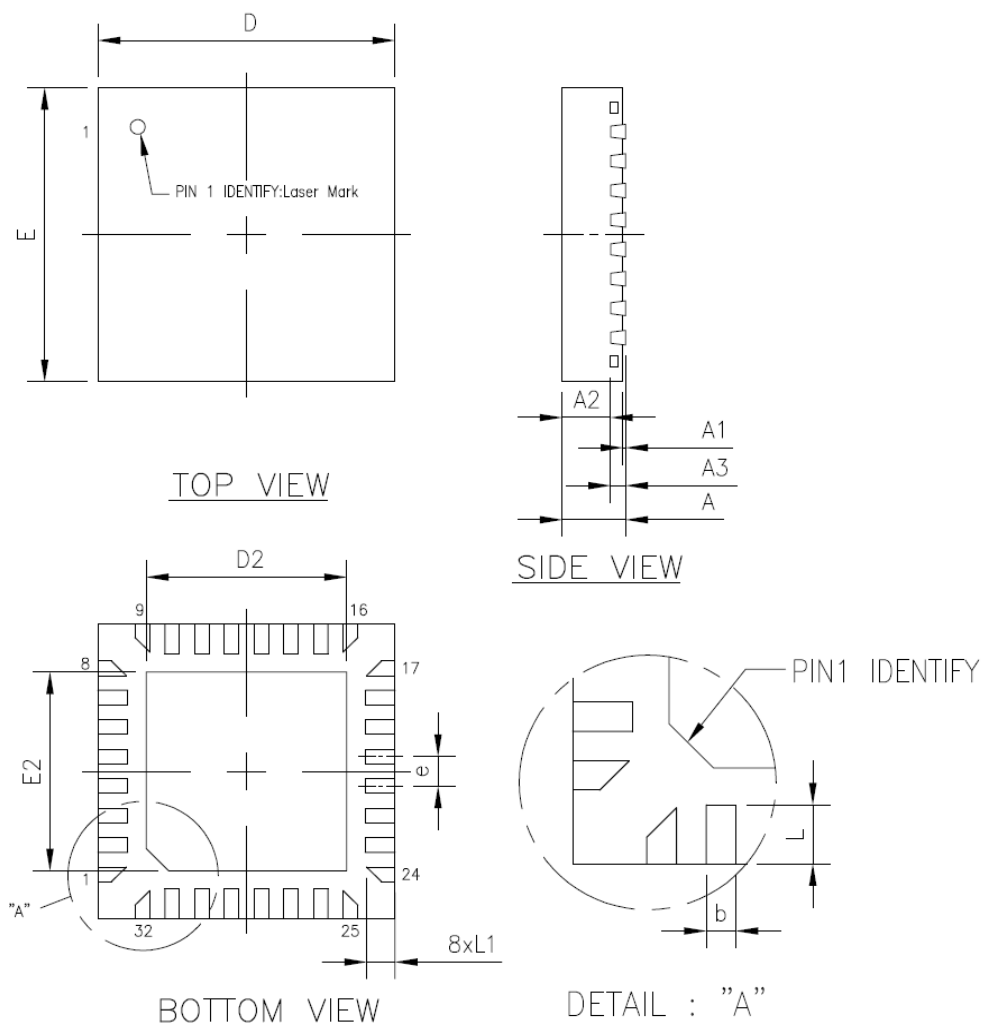


Figure 11. Auxiliary Signal Timing

9. Mechanical Dimensions



| Symbol | Dimension in mm | | | Dimension in inch | | |
|--------|-----------------|-------|-------|-------------------|-------|-------|
| | Min | Nom | Max | Min | Nom | Max |
| A | 0.80 | 0.85 | 0.90 | 0.031 | 0.033 | 0.035 |
| A1 | 0.00 | 0.02 | 0.05 | 0.000 | 0.001 | 0.002 |
| A2 | - | 0.65 | 0.70 | - | 0.026 | 0.028 |
| A3 | 0.20 REF | | | 0.008 REF | | |
| b | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 |
| D/E | 4.00 BSC | | | 0.157 BSC | | |
| D2/E2 | 2.55 | 2.70 | 2.85 | 0.100 | 0.106 | 0.112 |
| e | 0.40 BSC | | | 0.016 BSC | | |
| L | 0.30 | 0.40 | 0.50 | 0.012 | 0.016 | 0.020 |
| L1 | 0.282 | 0.382 | 0.482 | 0.011 | 0.015 | 0.019 |

Note 1: CONTROLLING DIMENSION: MILLIMETER (mm).

Note 2: REFERENCE DOCUMENT: JEDEC MO-220.

10. Ordering Information

Table 30. Ordering Information

| Part Number | Package | Status |
|---------------|----------------------------|--------|
| RTL8111GUS-CG | 32-Pin QFN 'Green' Package | - |

Note: See page 4 for package identification information.

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